Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

P-Channel Power MOSFET

-30V, -36A, 15mΩ

FEATURES

- Low $R_{DS(ON)}$ to minimize conductive Loss
- Low gate charge for fast power switching
- 100% UIS tested
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

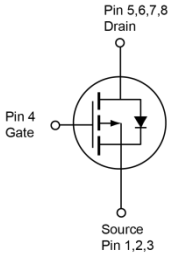
PRODUCT SUMMARY			
PARAMETER		**VALUE**	**UNIT**
V_{DS}		-30	V
$R_{DS(on)}$ (max)	V_{GS} = -10V	15	mΩ
	V_{GS} = -4.5V	30	
Q_g		14.3	nC

APPLICATIONS

- DC-DC Converters
- Battery Power Management
- Oring FET/Load Switch

Pb-Free RoHS COMPLIANT HALOGEN FREE

PDFN33



Note: MSL 1 (Moisture Sensitivity Level) per J-STD-020

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)				
PARAMETER		**SYMBOL**	**LIMIT**	**UNIT**
Drain-Source Voltage		V_{DS}	-30	V
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current (Note 1)	T_C = 25°C	I_D	-36	A
	T_A = 25°C		-10	
Pulsed Drain Current (Note 1)		I_{DM}	-144	A
Single Pulse Avalanche Current (Note 2)		I_{AS}	-31	A
Single Pulse Avalanche Energy (Note 2)		E_{AS}	48	mJ
Total Power Dissipation	T_C = 25°C	P_D	27.8	W
	T_C = 125°C		5.5	
Total Power Dissipation	T_A = 25°C	P_D	2.3	W
	T_A = 125°C		0.5	
Operating Junction and Storage Temperature Range		T_J, T_{STG}	- 55 to +150	°C

THERMAL RESISTANCE			
PARAMETER	**SYMBOL**	**LIMIT**	**UNIT**
Thermal Resistance – Junction to Case	$R_{\Theta JC}$	4.5	°C/W
Thermal Resistance – Junction to Ambient	$R_{\Theta JA}$	53	°C/W

Notes: $R_{\Theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. The case-thermal reference is defined at the solder mounting surface of the drain pins. $R_{\Theta JA}$ is guaranteed by design while $R_{\Theta CA}$ is determined by the user's board design.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)						
PARAMETER	**CONDITIONS**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Static (Note 3)						
Drain-Source Breakdown Voltage	V_{GS} = 0V, I_D = -250μA	BV_{DSS}	-30	--	--	V
Gate Threshold Voltage	V_{GS} = V_{DS}, I_D = -250μA	$V_{GS(TH)}$	-1.2	-1.6	-2.5	V
Gate-Source Leakage Current	V_{GS} = ±20V, V_{DS} = 0V	I_{GSS}	--	--	±100	nA
Drain-Source Leakage Current	V_{GS} = 0V, V_{DS} = -30V	I_{DSS}	--	--	-1	μA
Drain-Source On-State Resistance	V_{GS} = -10V, I_D = -10A	$R_{DS(on)}$	--	13	15	mΩ
	V_{GS} = -4.5V, I_D = -10A		--	22	30	
Forward Transconductance	V_{DS} = -5V, I_D = -10A	g_{fs}	--	19	--	S
Dynamic (Note 4)						
Total Gate Charge	V_{GS} = -10V, V_{DS} = -15V, I_D = -10A	Q_g	--	29.3	--	nC
Total Gate Charge	V_{GS} = -4.5V, V_{DS} = -15V, I_D = -10A	Q_g		14.3		
Gate-Source Charge		Q_{gs}	--	5.9	--	
Gate-Drain Charge		Q_{gd}	--	5.2	--	
Input Capacitance	V_{GS} = 0V, V_{DS} = -15V, f = 1.0MHz	C_{iss}	--	1829	--	pF
Output Capacitance		C_{oss}	--	227	--	
Reverse Transfer Capacitance		C_{rss}	--	160	--	
Switching (Note 4)						
Turn-On Delay Time	V_{GS} = -10V, V_{DS} = -15V, I_D = -1A, R_G = 6Ω,	$t_{d(on)}$	--	9	--	ns
Rise Time		t_r	--	21.8	--	
Turn-Off Delay Time		$t_{d(off)}$	--	59.8	--	
Fall Time		t_f	--	14.4	--	
Source-Drain Diode (Note 3)						
Diode Forward Voltage	V_{GS} = 0V, I_S = -10A	V_{SD}	--	--	-1	V
Reverse Recovery Time	I_S = -10A, di/dt = 100A/μs	t_{rr}	--	34	--	ns
Reverse Recovery Charge		Q_{rr}	--	23	--	nC

Notes:

1. Current limited by package.
2. L = 0.1mH, V_{GS} = -10V, V_{DS} = -25V, R_G = 25Ω, I_{AS} = -31A, Starting T_J = 25°C
3. Pulse test: Pulse Width ≤ 300μs, duty cycle ≤ 2%.
4. Switching time is essentially independent of operating temperature.

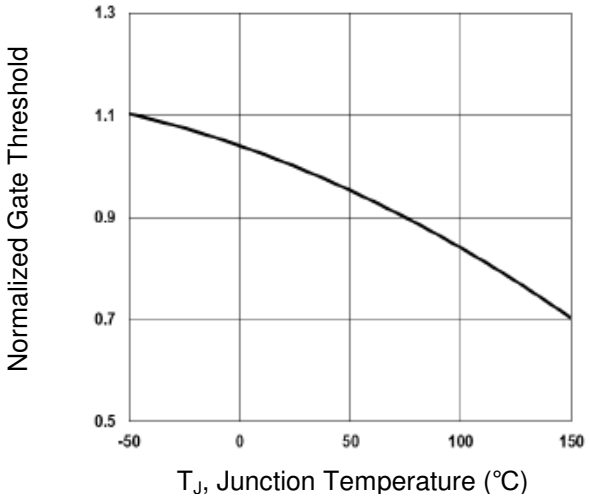
ORDERING INFORMATION

PART NO.	PACKAGE	PACKING
TSM150P03PQ33 RGG	PDFN33	5,000pcs / 13” Reel

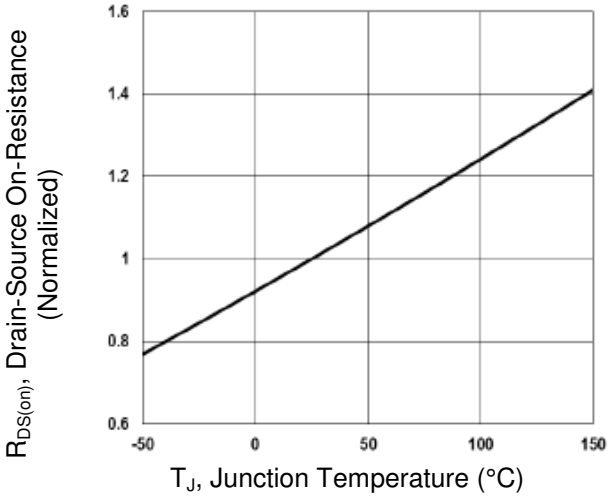
CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

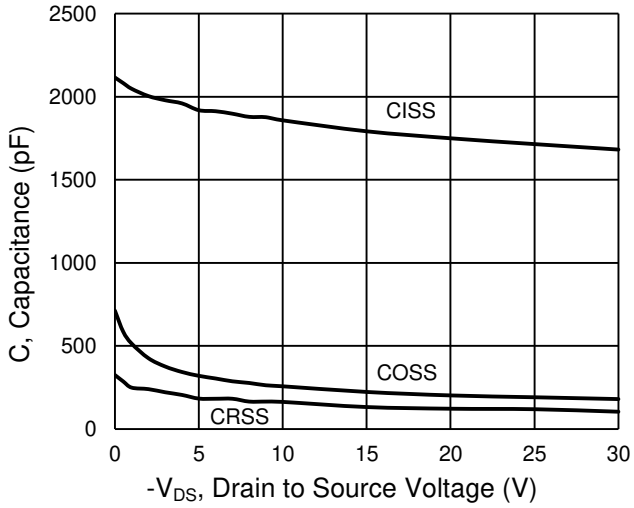
Normalized V_{th} vs. T_J



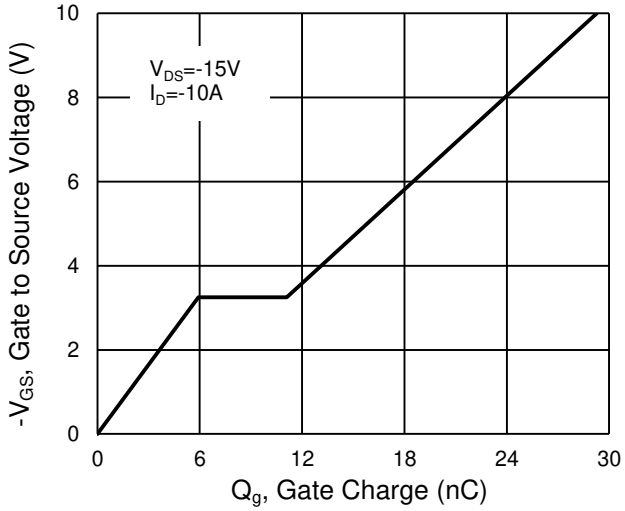
On-Resistance vs. Junction Temperature



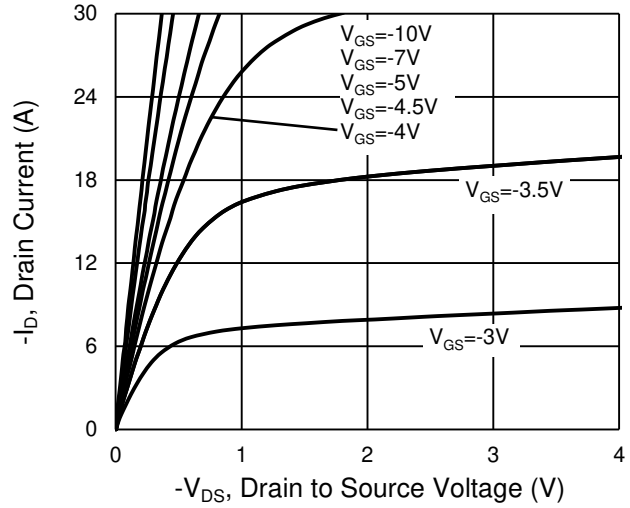
Capacitance vs. Drain-Source Voltage



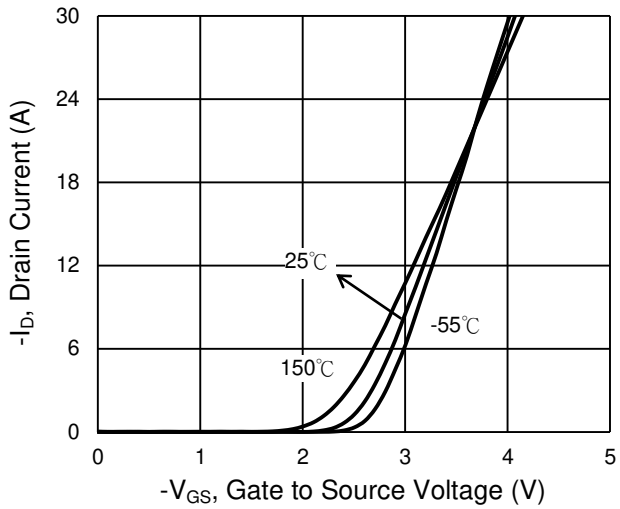
Gate-Source Voltage vs. Gate Charge



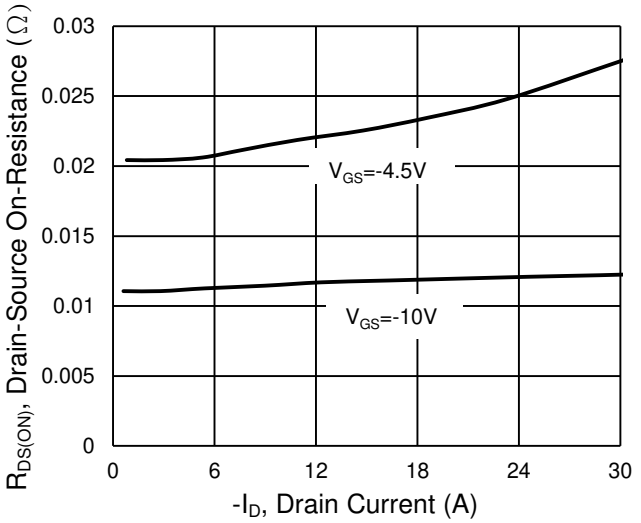
Output Characteristics



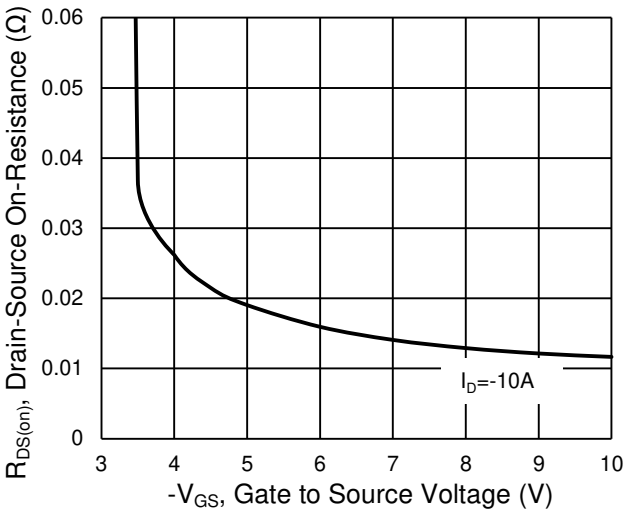
Transfer Characteristics



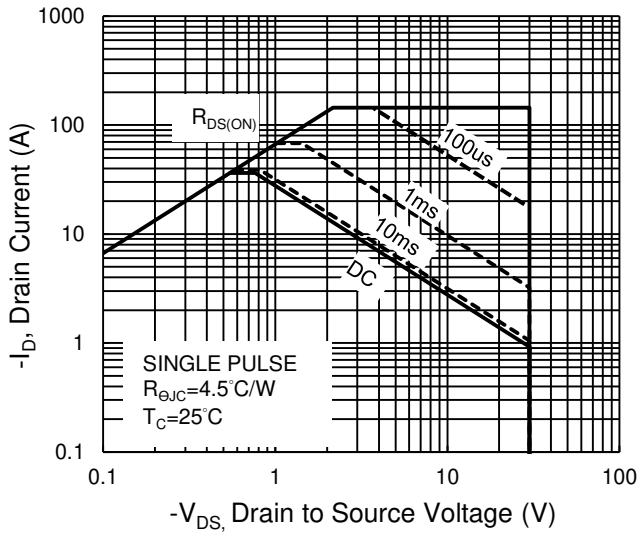
On-Resistance vs. Drain Current



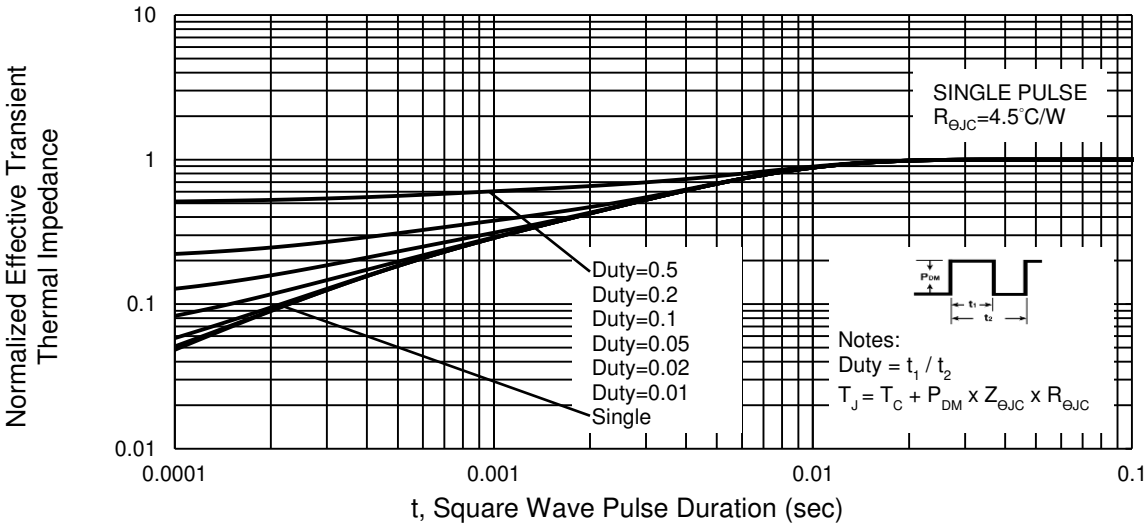
On-Resistance vs. Gate-Source Voltage



Maximum Safe Operating Area, Junction-to-Case

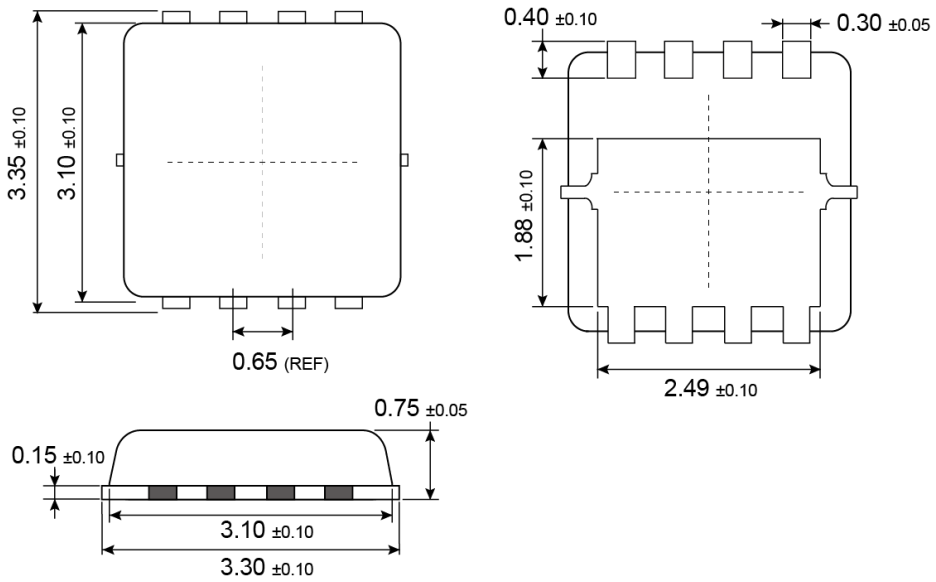


Normalized Thermal Transient Impedance, Junction-to-Case

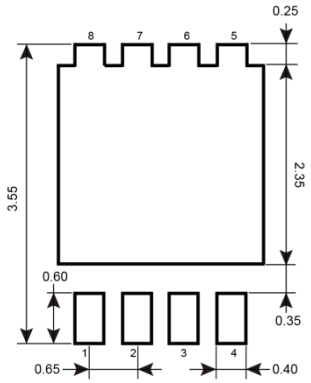


PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

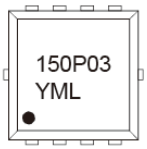
PDFN33



SUGGESTED PAD LAYOUT (Unit: Millimeters)



MARKING DIAGRAM



Y = Year Code

M = Month Code for Halogen Free Product

O	=Jan	**P**	=Feb	**Q**	=Mar	**R**	=Apr
S	=May	**T**	=Jun	**U**	=Jul	**V**	=Aug
W	=Sep	**X**	=Oct	**Y**	=Nov	**Z**	=Dec

L = Lot Code (1~9, A~Z)

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